

(11) Publication number:

U:

Generated Document

## PATENT ABSTRACTS OF JAPAN

(21) Application number: 06133496

(51) Intl. Cl.: H01L 21/68 G01B 11/26 H0

H01L 27/14

(22) Application date: 16.06.94

(30) Priority: publication:

12.01.96

(71) Applicant: NEC YAMAGATA LTD (72) Inventor: SATO KATSUAKI

(84) Designated contracting

(43) Date of application

states:

(74) Representative:

## (54) WAFER POSITIONING APPARATUS

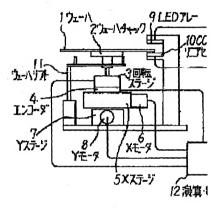
(57) Abstract:

PURPOSE: To realize highly accurate centering of a wafer by measuring the positional shift between the centers of the wafer and a rotary stage and the position of orientation flat based on the signals from an angle sensor and a CCD linear sensor.

CONSTITUTION: A wafer 1 is sucked to a wafer chuck 2 fixed to a rotary stage 3 also fixed with an angle detector 4. A light projecting section comprises an LED array 9 and a CCD linear sensor 10 is disposed on the water surface closely to the under side thereof. An operation control section 12 measures the positional shift between the centers of the wafer and the rotary stage, as well as the position of orientation flat, using the single CCD linear sensor 10 so that the positional shift can be corrected and the orientation flat can be

positioned. This structure can decrease the number of components and since no error is produced theoretically, highly accurate centering of wafer can be realized.

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Other Views: INPADOC

Title: JP8008328A2: WAFER POSITIONING APPARATUS

Country: JP Japan

Kind: A (See also: JP8008328B4 )

Inventor(s): SATO KATSUAKI

Applicant/Assignee:

NEC YAMAGATA LTD

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Issued/Filed Dates: Jan. 12, 1996 / June 16, 1994

Application Number: JP1994000133496

Abstract:

ness Intelligence Report

IPC Class: H01L 21/68; G01B 11/26; H01L 21/027; H01L 27/14;

Priority Number(s): June 16, 1994 JP1994000133496

Purpose: To realize highly accurate centering of a wafer by measuring the positional shift between the centers of the wafer and a rotary stage and the position of orientation

by measuring the positionary in the water and a rotary stage and the position of orientation flat based on the signals from an angle sensor and a CCD linear sensor.

Constitution: A wafer 1 is sucked to a wafer chuck 2 fixed to a rotary stage 3 also fixed with an angle detector 4. A light projecting section comprises an LED array 9 and a CCD linear sensor 10 is disposed on the water surface closely to the under side thereof. An operation control section 12 measures the positional shift between the centers of the wafer and the rotary stage, as well as the position of orientation flat, using the single CCD linear sensor 10 so that the positional shift can be corrected and the orientation flat can be positioned. This structure can decrease the number of components and since no error is produced theoretically, highly accurate centering of wafer

can be realized. COPYRIGHT: (C)1996,JPO

Family: Show known family members

Other Abstract Info: DERABS G96-102640 DERG96-102640

Foreign References: No patents reference this one

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